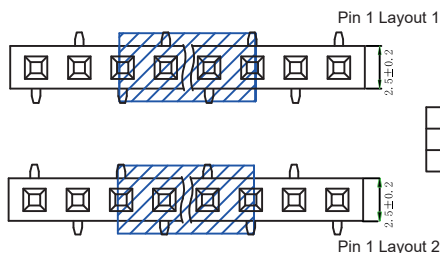
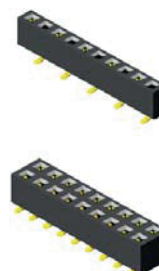
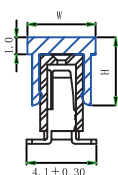
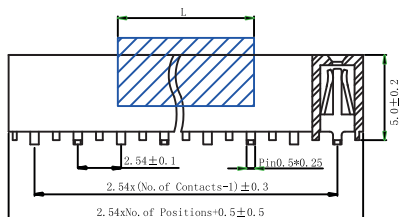


SMD Buchsenleisten Raster 2,54mm / SMT Female Header pitch 2,54mm

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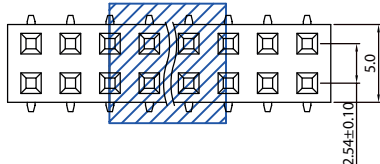


Cap	L	W	H(Ref.)
>4Pin	8.0	4.2	4.0
≤4Pin	5.1	3.4	2.25

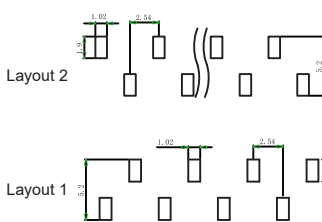
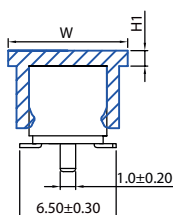
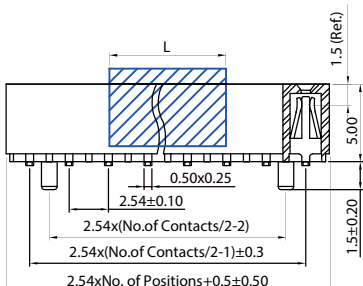


Bauhöhe 5,00mm
total height 5,00mm

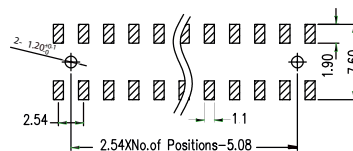
Für Vierkantstift 0,64mm
for square pin 0,64mm



Cap	L	W	H1(Ref.)
>4Pin	7.5	7.7	1.0
≤4Pin	5.2	6.5	1.0



Empfohlenes Leiterplatten Layout
Recommended P.C.B. Layout
(PCB Tolerance ±0,05)



Technische Daten / Technical Data
Isolierkörper / Insulator Nylon 6T (UL94-V0)
Kontaktmaterial / Contact material Phosphor Bronze
Nennspannung / Current Voltage 250V AC
Nennstrom / Current Rating 3A
Temperaturbereich / Temperature Range -40°C...+105°C
Lötwärmebeständigkeit / Resistance soldering 235°C (30-60 sec.)
260°C (10 sec.)

weitere Informationen auf Anfrage / more information on request

Bestellbeispiel
How to order

Bitte ersetzen Sie X durch unten aufgeführten Code
Please replace X with coding listed below

00= ohne Positionierhilfe / without locating peg
01= mit Positionierhilfe / with locating peg (nur 2-reihig / only 2-row)

Veredelung / Plating
FL= Flash vergoldet /Flash gold plating **00**= verzinkt / tin plating
(andere Veredelungen auf Anfrage / other platings on request)

Anzahl Reihe / Number of row
1= 1-reihig / 1-row **2**= 2-reihig / 2-row

Ausführung / Version
1= stehend / standing

Raster / Pitch
2= 2,54mm **9**= Sonderraster / other pitch

1= Layout 1 (nur 1-reihig / only 1-row) **2**= Layout 2 (nur 1-reihig / only 1-row) **0**= 2-reihig / 2-row

Polzahl / Number of contacts
04...40 (1-reihig / 1-row), **04...80** (2-reihig / 2-row)

Pick and Place Pad option
0= ohne / without PP-Pad **1**= mit / with PP-Pad

Verpackung / Packaging
1= Stange / Tube (Standard) **2**=Rolle / Reel (auf Anfrage / on request) **3**= Blister / Tray

149 XX XX X 1 X X X X - X X